MOSPEC

COMPLEMENTARY SILICON HIGH-POWER TRANSISTORS

General-Purpose Power Amplifier and Switching Applications

FEATURES:

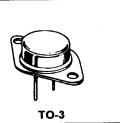
- * Low Collector-Emitter Saturation Voltage -
- V_{CE(SAT)}=1.0V(Max.)@I_C=7.0A * Execlient DC Current Gain
 - hFE = 20 ~ 100 @ I_c = 6.0 A

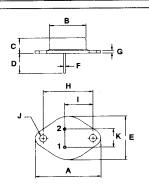
MAXIMUM RATINGS

Characteristic	Symbol	2N5879 2N5881	2N5880 2N5882	Unit
Collector-Emitter Voltage	V _{CEO}	60	80	v
Collector-Base Voltage	V _{CBO}	60	80	v
Emitter-Base Voltage	V _{EBO}	5	v	
Collector Current-Continuous -Peak	I _с I _{см}	1	A	
Base Current	۱ _в	5	A	
Total Power Dissipation@T _C =25°C Derate above 25°C	PD	160 0.915		W W/ºC
Operating and Storage Junction Temperature Range	T _J , T _{STG}	- 65 t	°C	

PNP NPN 2N5879 2N5881 2N5880 2N5882

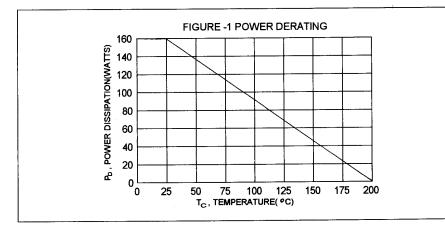
15 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 60 - 80 Volts 160 Watts



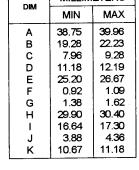


THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction to Case	Rejc	1.1	°C/W







2N5879, 2N5880 PNP / 2N5881, 2N5882 NPN

Characteristic		Symbol	Min	Max	Ünit
OFF CHARACTERISTICS					
Collector - Emitter Sustaining Voltage (1) (I _C = 200 mA, I _B = 0)	2N5879, 2N5881 2N5880, 2N5882	V _{CEO(SUS)}	60 80		V
Collector Cutoff Current ($V_{cE} = 30 V$, $I_{g} = 0$) ($V_{cE} = 40 V$, $I_{g} = 0$)	2N5879, 2N5881 2N5880, 2N5882	I _{CEO}		1.0 1.0	mA
	2N5879, 2N5881 2N5880, 2N5882 2N5879, 2N5881 2N5880, 2N5882	ICEX		0.5 0.5 5.0 5.0	mA
Collector Cutoff Current ($V_{CB} = 60 V$, $I_E = 0$) ($V_{CB} = 80 V$, $I_E = 0$)	2N5879, 2N5881 2N5880, 2N5882	I _{CBO}		0.5 0.5	mA
Emitter Cutoff Current ($V_{EB} = 5.0 V$, $I_{C} = 0$)		I _{EBO}		1.0	mA

ON CHARACTERISTICS (1)

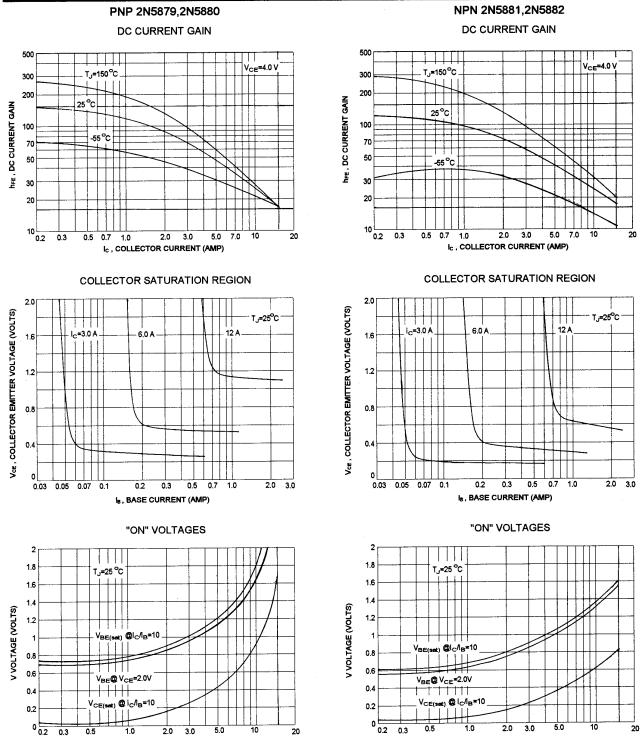
DC Current Gain $(I_c = 2.0 \text{ A}, V_{cE} = 4.0 \text{ V})$ $(I_c = 6.0 \text{ A}, V_{cE} = 4.0 \text{ V})$ $(I_c = 15 \text{ A}, V_{cE} = 4.0 \text{ V})$	hFE	35 20 4.0	100	
Collector-Emitter Saturation Voltage ($l_c = 7.0 \text{ A}, l_g = 0.7 \text{ A}$) ($l_c = 15 \text{ A}, l_g = 3.75\text{ A}$)	V _{CE(sat)}		1.0 4.0	V
Base-Emitter On Voitage (I _C = 6.0 A, V _{CE} = 4.0 V)	V _{BE(on)}		1.5	v
Base-Emitter Saturation Voltage (I _C = 15 A, I _B = 3.75 A)	V _{BE(sat)}		2.5	v

DYNAMIC CHARACTERISTICS

Current-Gain-Bandwidth Product (2) ($I_c = 1.0 \text{ A}, V_{CE} = 10 \text{ V}, \text{ f} = 1.0 \text{ MHz}$)	f _T	4.0	MHz
Small-Signal Current Gain (I _c = 2.0 A, V _{cE} = 4.0 V, f = 1.0 KHZ)	h _{fe}	20	

(1) Pulse Test: Pulse width \leq 300 us , Duty Cycle \leq 2.0%

(2) $f_T = |h_{f_0}| \circ f_{test}$



IC , COLLECTOR CURRENT (AMP)

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100 70 50 = 500us 1 ms 100 us 5 ms k 30 20 COLLECTOR CURRENT (Amp) 10 7 de 2 Bonding Wire Limit Thermally Limited T_c=25^oC (Single Pulse) 0.7 0.5 Second Breakdown Limit 2N5879,2N5881 2N5880,2N5882 <u>_</u>

ACTIVE-REGION SAFE OPERATING AREA (SOA)

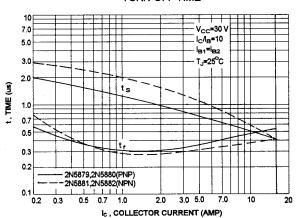
10 VCE , COLLECTOR EMITTER VOLTAGE (VOLTS)

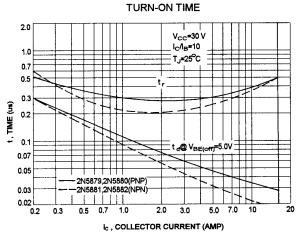
5 7

0.2 0.1

2 3

TURN-OFF TIME





20 30 50

100

70

There are two limitation on the power handling ability of a transistor:average junction temperature and second breakdown safe operating area curves indicate Ic-VCE limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than curves indicate.

The data of SOA curve is base on $T_{J(PK)}=200$ °C;T_c is variable depending on conditions. second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(PK)} \leq 200^{\circ}$ C,At high case temperatures, thermal limita tion will reduce the power that can be handled to values less than the limitations imposed by second breakdown.



